Docket No.

ET

0756-1842

MRD 10-8-98

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o th	e Hono	rable C	Commissioner	of Patent and	Trademarks.	Please record the	attached ori	ginal doci	iments or	copy there	of.

Additional name(s) of conveying party(ies) attached? Yes _X _ No 2. Name and address of receiving party(ies): Name: Semiconductor Energy Laboratory Co., Ltd. Street Address: 398, Hase, Atsugi-shi City Kanagawa-ken State Japan ZIP 243-0036 Additional name(s) & addresses(es) attached? Yes X No	
Name: Semiconductor Energy Laboratory Co., Ltd. Street Address: 398, Hase, Atsugi-shi City Kanagawa-ken State Japan ZIP 243-0036	
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Additional name(s) & addresses(es) attached? YesX_ No	
3. Name of Conveyance:	
X Assignment Merger	
Security Agreement Change of Name	
Other	
Execution Date:	
4. Application number(s) or patent number(s):	
If this document is being filed together with a new application, the execution date of the application is:	
A: Patent Application No. 09/120,244 B. Patent No.(s)	
Additional numbers attached? Yes _X No	
5. Name and address of party to whom correspondence concerning document should be mailed:	
Name: Sixbey, Friedman, Leedom & Ferguson, P.C.	
Street Address: 2010 Corporate Ridge, Suite 600	,
City: McLean State: Virginia ZIP 22102	
City. Niebeum State.	
6. Total number of applications and patents involved:	
7. Total fee (37 CFR 3.41):\$\\\\40.00	
X_ Enclosed	
Authorized to be charged to deposit account	
X Authorized to charge any deficiency in the payment of the required fee(s) or credit any overpayment to Deposit Ac	count
No. 19-2380.	
8. Deposit Account Number: 19-2380	
8. Deposit Account Number: 19-2380 (Attach duplicate copy of this page if paying by deposit account)	
15/1998 TIUMI 00000223 09120244 DO NOT USE THIS SPACE	
FC:581 40.00 (IP	
9. Statement and signature.	
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy	of the
original document.	
Gerald J. Ferguson, Jr.	
Name of Person Signing Signature Date ' Total number of pages comprising cover sheet, attachments and document: 3	

PATENT

REEL: 9502 FRAME: 0416

ATTOKNEY DOCKET NO.

0756-1842

ASSIGNMENT

	Serial No. 09/	120,244	Filed_	July 22,	1998			
	WHEREAS,	Hisashi OHTANI,						
	***************************************	Tamae TAKANO and						
Insert Name(s) of Inventor(s)		Chiho KOKUBO						
Insert Title of	(hereinafter designat	ed as the undersigned) has (have) inver	nted certain new and us	seful improvements	s in			
Invention	-	SEMICONDUCTOR DEVICE AND FABRICATING						
		METHOD THEREOF						
Insert Date of Signing of Application	for which an applica	tion for Letters Patent of the United Sta		m executed by the	-			
	WHEREAS,	SEMICONDUCTOR ENER	GY LABORATORY	Y CO., LTD	•			
Insert Name of Assignce								
Insert Address of Assignce	of	398, Hase, Atsugi-	shi, Kanagawa	a-ken 243-	0036 Japai			
		, legal representatives and assigns (legal title and interest in and to said in	-	=				

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents do sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America and its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America and its territories, dependencies and possessions, and in and to any and all divisions, reissues, continuations and extensions thereof for the full term or terms for which the same may be granted.

granted therefor in the United States of America;

Revised 11190

PATENT REEL: 9502 FRAME: 0417

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference v hich may be declared concerning this application or any continuation, division or reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims under or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue any and all Letters Patents of the United States of America resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby convenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Sixbey, Friedman, Leedom & Ferguson, P.C. the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

In witness whereof, this Assignment has been executed by the undersigned on the date(s) opposite the undersigned name(s).

Date 09/10/1998	, Name of Inventor Hisashi OH'		(SEAL)
Date 09/10/1998	, Name of Inventor Tamae TAKAI	Tamae Takano NO (signature)	(SEAL)
Date 09/10/1998	, Name of Inventor <u>C</u> Chiho KOKU		(SEAL)
Date	, Name of Inventor	(signature)	(SEAL)
Date	, Name of Inventor	(signature)	(SEAL)
(This assignment should preferably the Inventor(s) should be witness		ted States Consul or Notary Public. If not, to who should sign here.)	then the execution
Witness	(name)	(signatur	re)
Witness	(name)	(signatus	re)
Witness			

(name)

RECORDED: 10/08/1998

PATENT REEL: 9502 FRAME: 0418

(signature)